

Semiconductor Talent Incubation Program Taiwan – STIPT call for Equipment Engineering participants

The STIPT program offers a financially supported, **combined study and internship period** in the semiconductor field.

Hosts during the winter semester 2025/2026 will be the Taiwan universities **NYCU and Taiwan Tech** (4 months) as well as **TSMC** (2 months).

Target group

equipment engineering students
with particular interest in

- Electric Machinery and Circuitry
- Mechatronics and Automation application
- Sensing technology
- Mechanism Design and Processing
- Robotics and Automation application
- and related subjects

Application period

November 11 – December 31, 2024

Further program information and selection criteria

